MOSFETs Silicon P-Channel MOS (U-MOSVI)

TPCA8123

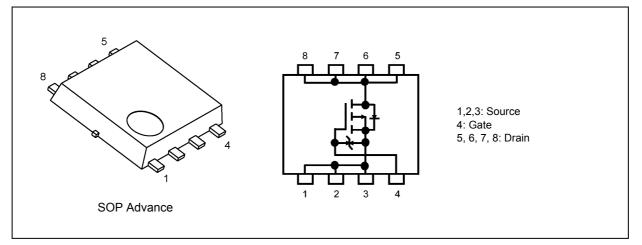
1. Applications

- Motor Drivers
- Switching Voltage Regulators

2. Features

- (1) Small, thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 8.5 \text{ m}\Omega \text{ (typ.)} (V_{GS} = -10 \text{ V})$
- (3) Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -60 \ V)$
- (4) Enhancement mode: V_{th} = -2.0 to -3.0 V (V_{DS} = -10 V, I_D = -1.0 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteri	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	-60	V
Gate-source voltage			V _{GSS}	-20/+10	
Drain current (DC)		(Note 1)	Ι _D	-50	A
Drain current (pulsed)		(Note 1)	I _{DP}	-150	
Power dissipation	(T _c = 25°C)		PD	84	W
Power dissipation	(t = 10 s)	(Note 2)	PD	3.3	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.9	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	206	mJ
Avalanche current			I _{AR}	-50	A
Channel temperature		(Note 5)	T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteris	Symbol	Max	Unit		
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	1.78	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	44.6	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	78.1	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

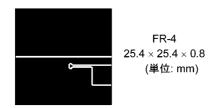
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

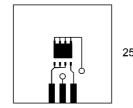
Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = -25 V, T_{ch} = 25°C (initial), L = 112 μ H, R_G = 25 Ω , I_{AR} = -50 A

Note 5: Merely channel temperature is guaranteed 175°C.

Storage temperature range is guaranteed as usual (-55 to 150°C).





FR-4 25.4 × 25.4 × 0.8 (単位: mm)

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a) Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

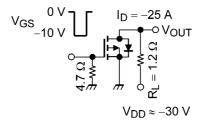
6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = -16/+10 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	—	—	-10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = -10 mA, V _{GS} = 0 V	-60	_	_	V
Drain-source breakdown voltage (Note 6)	V _{(BR)DSX}	I _D = -10 mA, V _{GS} = 10 V	-50	_	_	
Gate threshold voltage	V _{th}	V _{DS} = -10 V, I _D = -1.0 mA	-2.0	—	-3.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = -6 V, I _D = -25 A	—	9.3	14.9	mΩ
		V _{GS} = -10 V, I _D = -25 A	_	8.5	11.1	

Note 6: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	7000	_	pF
Reverse transfer capacitance	C _{rss}			540	_	
Output capacitance	C _{oss}			680	_	
Switching time (rise time)	t _r	See Figure 6.2.1.	_	7	_	ns
Switching time (turn-on time)	t _{on}		_	17	—	
Switching time (fall time)	t _f		_	110	—	
Switching time (turn-off time)	t _{off}		_	553	_	



 $Duty \le 1\%, \ t_w = 10 \ \mu s$ Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

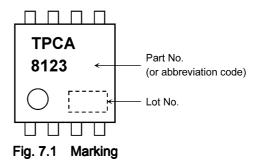
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx$ -48 V, V_{GS} = -10 V, I_D = -50 A	—	163	—	nC
Gate-source charge 1	Q _{gs1}		_	24	_	
Gate-drain charge	Q _{gd}		_	48	_	

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

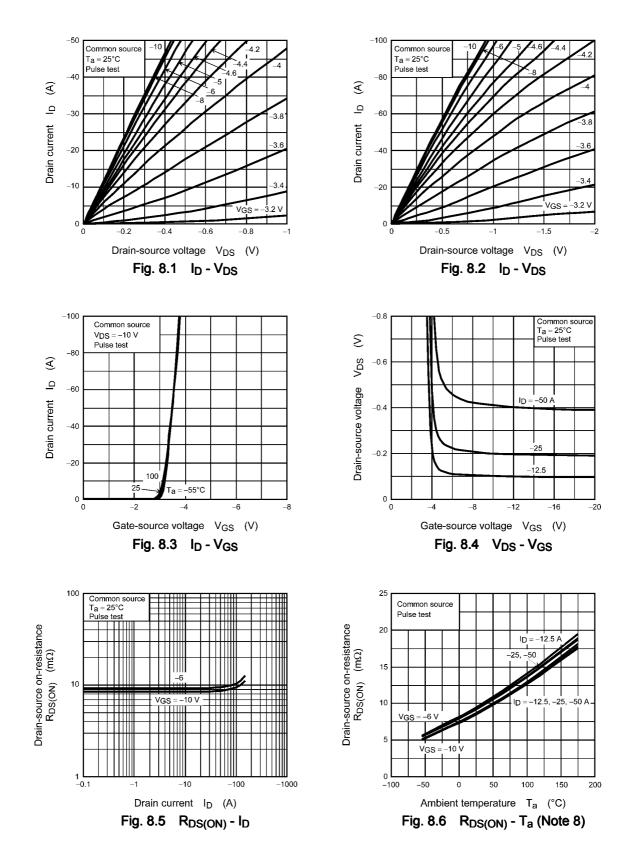
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 7)	I _{DRP}	—	_	_	-150	А
Diode forward voltage		V _{DSF}	I _{DR} = -50 A, V _{GS} = 0 V	_	_	1.2	V

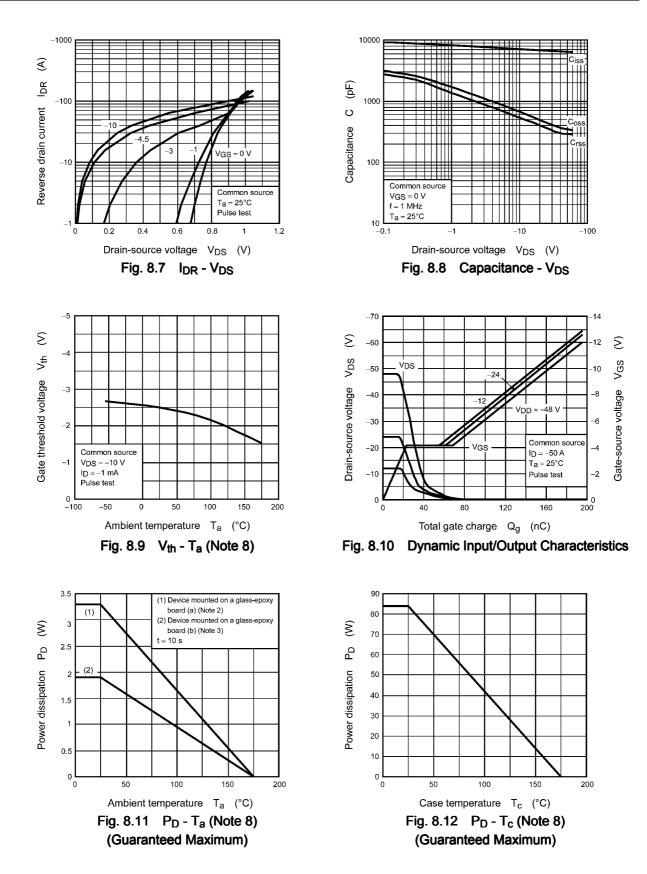
Note 7: Ensure that the channel temperature does not exceed 175°C.

7. Marking

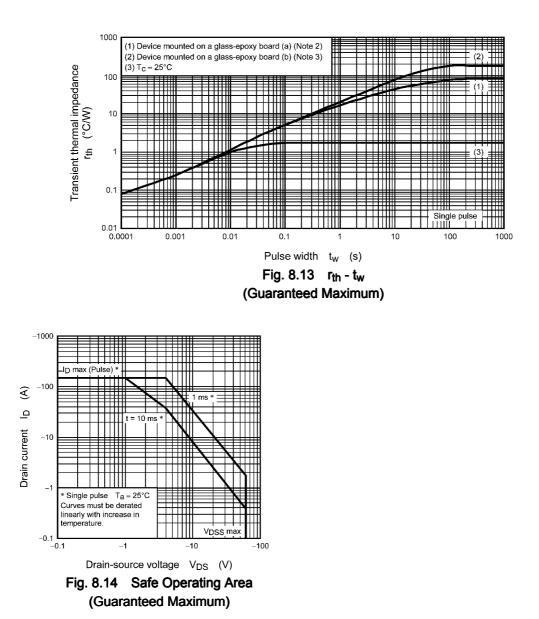


8. Characteristics Curves (Note)









Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

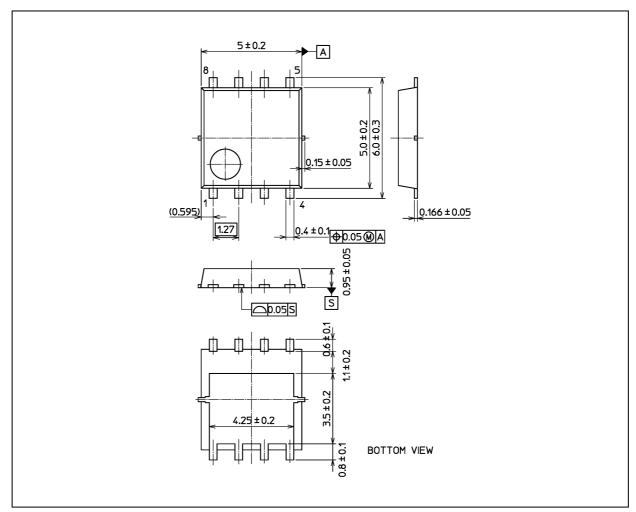
Note 8: Although several performance curves are shown up to a T_a or T_c of 175°C, the device is not guaranteed at storage temperatures up to 175°C. The storage temperature (T_{stg}) range is rated at -55°C to 150°C.



TPCA8123

Package Dimensions

Unit: mm



Weight: 0.069 g (typ.)

TOSHIBA: 2-5Q1S

Nickname: SOP Advance

Package Name(s)

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